

Reply under 37 C.F.R. 1.116
Expedited Procedure
Technology Center 2822

Confirmation No. 3088

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| Applicant: | HESEN, <i>et al.</i> | Examiner: | Chhaya, S. |
| Serial No.: | 10/560,447 | Group Art Unit: | 2822 |
| Filed: | December 12, 2005 | Docket No.: | NL030692US1 |
| Title: | LEAD FRAME, METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE | | |

FINAL OFFICE ACTION AMENDMENT AND RESPONSE

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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| Customer No. 65913 |
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Dear Sir:

In response to the Final Office Action dated February 12, 2008, please reconsider the application in view of the following amendments and remarks.

A complete listing of the claims, to include any amendments presented therein, begins on page 2 of this paper.

Remarks/Arguments follow on page 7.

Authorization is provided to charge/credit Deposit Account 50-0996 (NXPS.316PA) any requisite fees/overages to enter this paper.